

Procedure file

Basic information	
DEA - Delegated acts procedure	2018/2604(DEA)
Exemption for lead in solders for the soldering to machined through hole discoidal and planar array ceramic multilayer capacitors	Procedure completed - delegated act enters into force
Supplementing <u>2008/0240(COD)</u>	
Subject 3.70.13 Dangerous substances, toxic and radioactive wastes (storage, transport)	
Documentation gateway	
Non-legislative basic document	<u>C(2018)01080</u>
	27/02/2018
	EC